

3rd International Conference on Research & Innovation in Computer, Electronics and Manufacturing Engineering (RICEME-17)

March 27-28, 2017 Singapore

New Submissions are OPEN and Full-length Papers/Short Papers/Posters/Abstracts can be submitted before Dec. 10, 2016

GENERAL INFORMATION

The idea of 3rd International Conference on Research & Innovation in Computer, Electronics and Manufacturing Engineering (RICEME-17) scheduled on March 27-28, 2017 Singapore is for the researchers, scientists, scholars, engineers and practitioners from all around the world to present and share ongoing research activities. This conference provides opportunities for the delegates to exchange new ideas and application experiences face to face, to establish business or research relations and to find global partners for future collaboration.

ONLINE PAPER SUBMISSION

Full-length Papers, Short Papers, Posters and Abstracts are invited that address the themes and topics for the conference, including figures, tables and references of novel research material. Please click at the "Paper Submission" link to submit your full-length papers and posters for the conference.

OR

PAPER SUBMISSION THROUGH EMAIL

Email the formatted paper according to the .doc template paper (in .doc or .docx format) at email id: - **conf@fenp.org** along with the name and city of the conference of the conference

The "oral presentation"; "Poster presentation" and "Video Conferencing" options are available Please mention your choice at the time of submission

The conference paper template and copyright form are available at: <http://fenp.org/conference/159> and can be downloaded using following links:

[IAAST Copyright Form](#)

[IAAST Journal/Conference Template](#)

CONFERENCE PROCEEDINGS

The International Refereed Conference Proceedings will be blind peer reviewed by two competent reviewers. The post conference proceedings will be submitted to be indexed in the Thomson Reuters, CiteSeerX, Google Books and Google Scholar for possible Indexing. The conference proceedings book with ISBN & CD and certificate of presentation will be distributed to the conference participants at the conference registration desk

One Best Paper will be selected from each oral session. The Certificate for Best Papers will be awarded after end of each session.

Important Dates:

TASK	Dates		
	Round-1	Round-2	Round-3
Deadline of NEW Full Paper/Abstract/Poster submission	Dec.10, 2016	Jan. 03, 2017	Feb. 03, 2017
Notification of acceptance	Dec. 20, 2016	Jan. 12, 2017	Feb. 09, 2017
Deadline for Camera ready and authors' registration	Dec. 30, 2016	Jan. 25, 2017	Feb. 20, 2017
Conference Dates	March 27-28, 2017		

Registration Fee:

Category	1st Round Registration Fees	2nd Round Registration Fees	3rd Round Registration Fees	4th Round Registration Fees
Author (Non-Student)*	USD 225	USD 250	USD 275	USD 300
Author (Student/Co-author/Listener)*	USD 175	USD 200	USD 225	USD 250
Additional Paper**	USD 90	USD 100	USD 110	USD 120
Extra Proceeding	USD 40	USD 50	USD 60	USD 70
Additional Pages	USD 15	USD 20	USD 25	USD 30

CONFERENCE VENUE

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